



**Pb-free
HEAT**



1113F Series

Single Color Right Angle Type (2.1 X 1.0 mm)

Features

Package	Right Angle Type (2.1 x 1.0 mm) Type, Milky White resin
Product features	<ul style="list-style-type: none"> • Outer Dimension 2.1 x 1.0 x 0.6mm (L x W x H) • Temperature range Storage Temperature : -40°C~100°C Operating Temperature : -30°C~85°C • Lead-free soldering compatible • RoHS compliant
Dominant wavelength	Green : 567nm(PG) Yellow Green : 572nm(PY) Red : 647nm(BR)
Half Intensity Angle	PG : $\theta_x = 145 \text{ deg.}, \theta_y = 147 \text{ deg.}$ PY : $\theta_x = 150 \text{ deg.}, \theta_y = 147 \text{ deg.}$ BR : $\theta_x = 131 \text{ deg.}, \theta_y = 153 \text{ deg.}$
Die materials	PG,PY : GaP, BR : GaAlAs
Rank grouping parameter	Sorted by luminous intensity per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering and manual soldering
Taping and reel	4,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: ϕ 180mm
ESD	More than 2kV(HBM)

Recommended Applications

Cellular Phone, Electric Household Appliances, OA/FA, Other General Applications

Color and Luminous Intensity

(Ta=25°C)

Part No.	Material	Emitted Color	Lens Color	Dominant Wavelength		Luminous Intensity		
				λ_d (nm)		Iv (mcd)		
				TYP.	I _f	MIN.	TYP.	I _f
PG1113F	GaP	Green	Milky White	567	20	3.8	6.4	20
PY1113F	GaP	Yellow Green		572	20	7.0	11.7	20
BR1113F	GaAlAs	Red		647	20	7.0	11.7	20

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings			Unit
		PG	PY	BR	
Power Dissipation	P_d	70	70	57.5	mW
Forward Current	I_F	25	25	25	mA
Pulse Forward Current ※1	I_{FRM}	60	60	60	mA
Derating (Ta=25°C or higher)	ΔI_F	0.36	0.36	0.36	mA/°C
	ΔI_{FRM}	0.86	0.86	0.86	mA/°C
Reverse Voltage	V_R	4	4	4	V
Operating Temperature	T_{opr}	-30~+85			°C
Storage Temperature	T_{stg}	-40~+100			°C

※1 I_{FRM} Measurement condition : Pulse Width ≤ 1 ms., Duty $\leq 1/20$.

Electro-Optical Characteristics

(Ta=25°C)

Item	Conditions	Symbol	Characteristics			Unit	
			PG	PY	BR		
Forward Voltage	I _F =20mA	V _F	TYP.	2.1	2.1	1.7	V
			MAX.	2.8	2.8	2.3	
Reverse Current	V _R =4V	I _R	MAX.	100	100	100	μ A
Peak Wavelength	I _F =20mA	λ _p	TYP.	560	570	660	nm
Dominant Wavelength	I _F =20mA	λ _d	TYP.	567	572	647	nm
Spectral Line Half Width	I _F =20mA	Δ λ	TYP.	30	30	30	nm
Half Intensity Angle	I _F =20mA	2 θ 1/2	TYP.	145(θ x)	150(θ x)	131(θ x)	deg.
				147(θ y)	147(θ y)	153(θ y)	

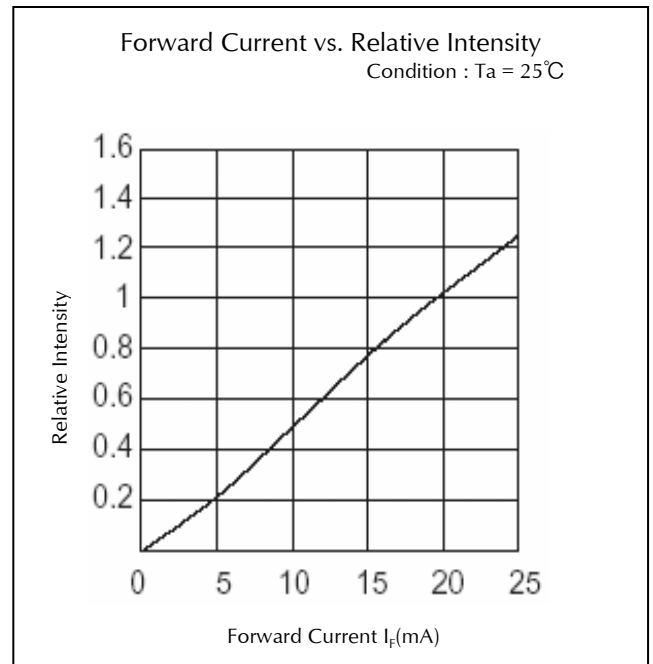
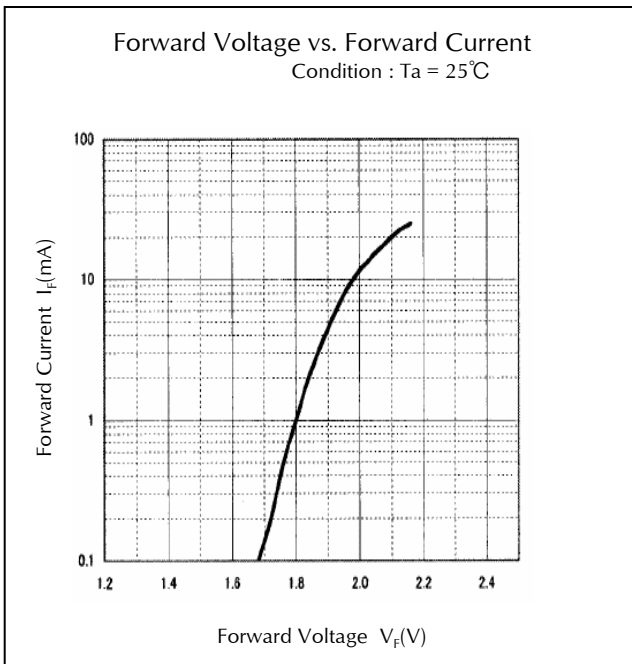
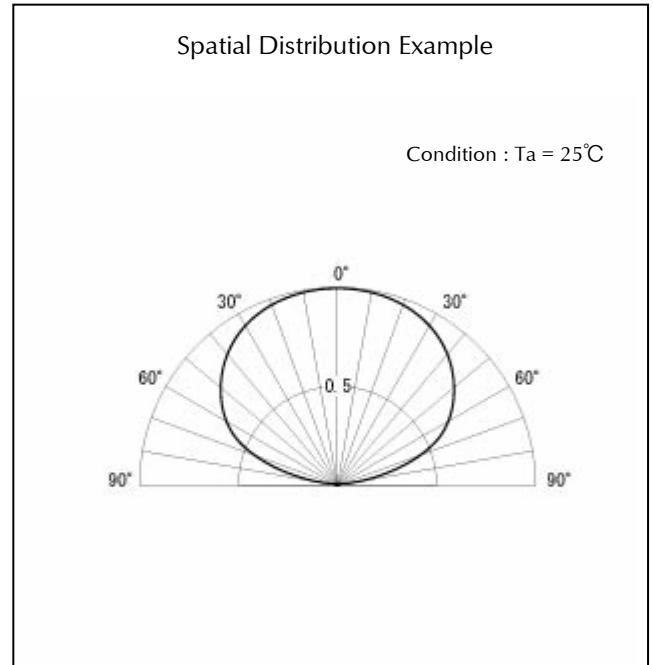
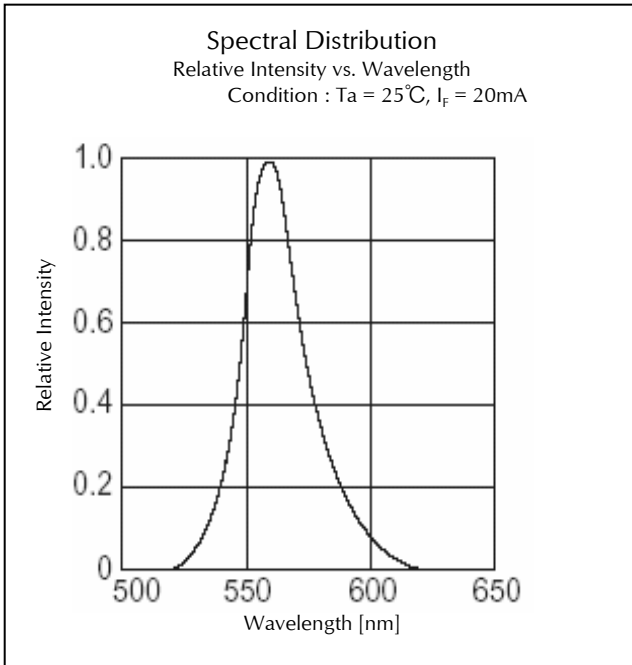
Luminous Intensity Rank

(Ta=25°C)

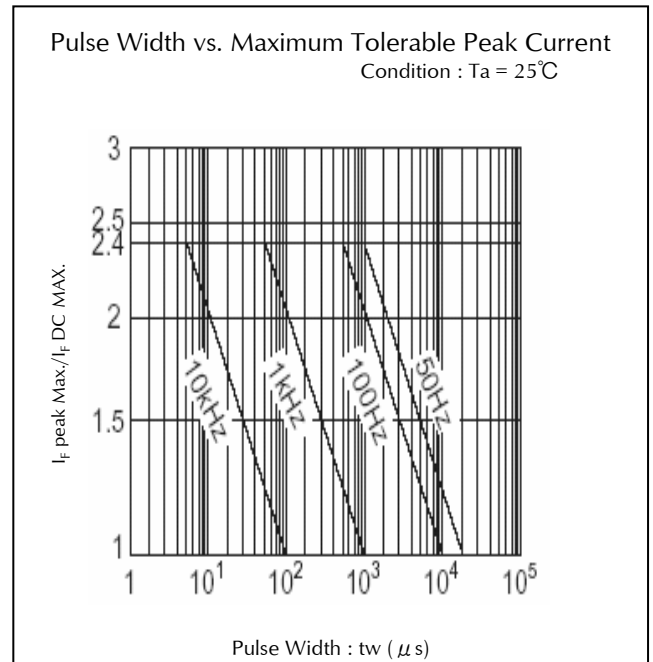
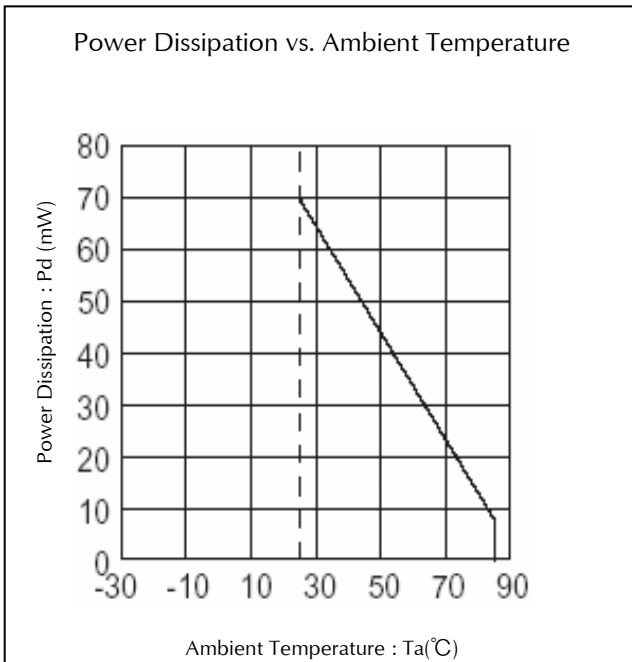
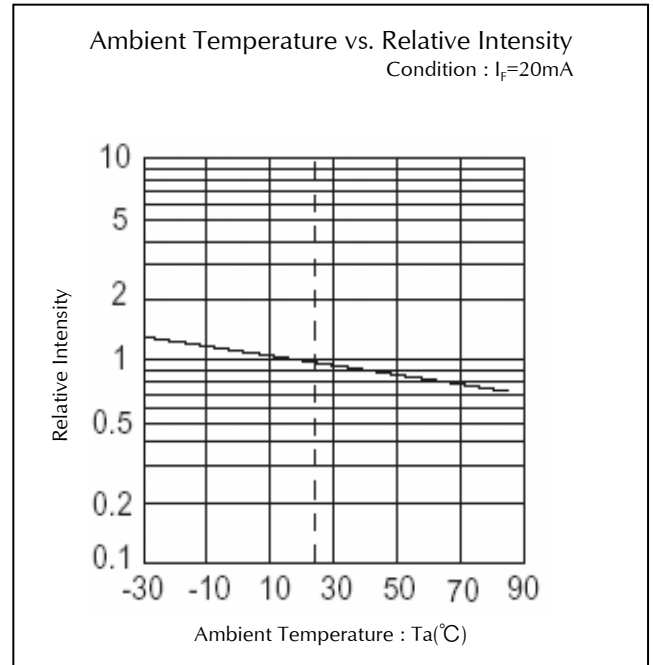
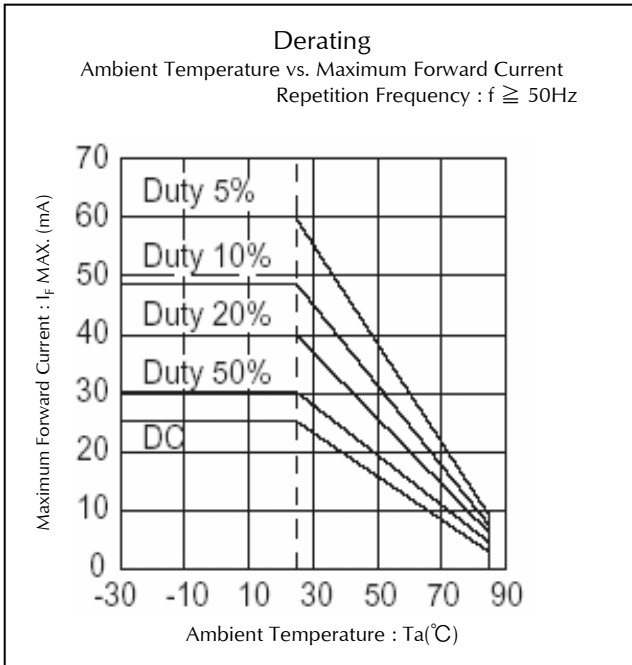
Rank	I _v (mcd)					
	PG		PY		BR	
	I _F =20mA		I _F =20mA		I _F =20mA	
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
A	3.8	5.4	7.0	9.9	7.0	9.9
B	4.5	6.4	8.3	11.7	8.3	11.7
C	5.4	7.6	9.9	14.0	9.9	14.0
D	6.4	9.0	11.7	16.5	11.7	16.5
E	7.6	10.7	14.0	19.8	14.0	19.8
F	9.0	-	16.5	-	16.5	-

※ Please contact our sales staff concerning rank designation.

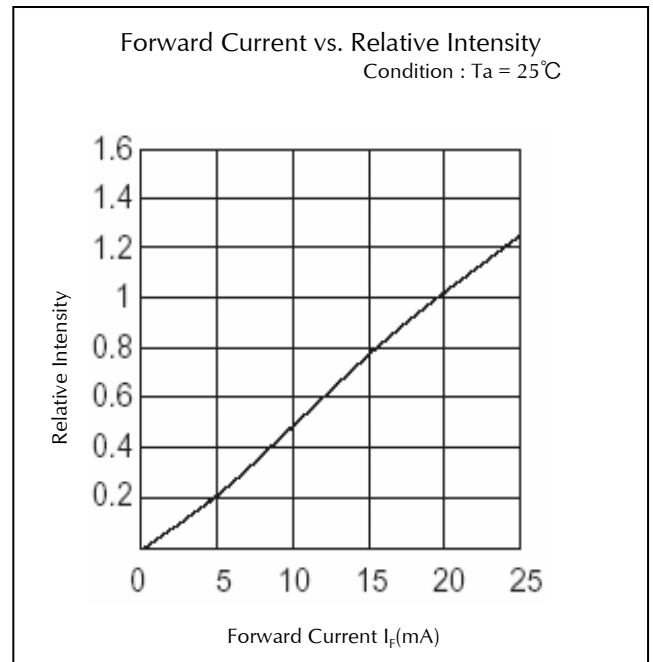
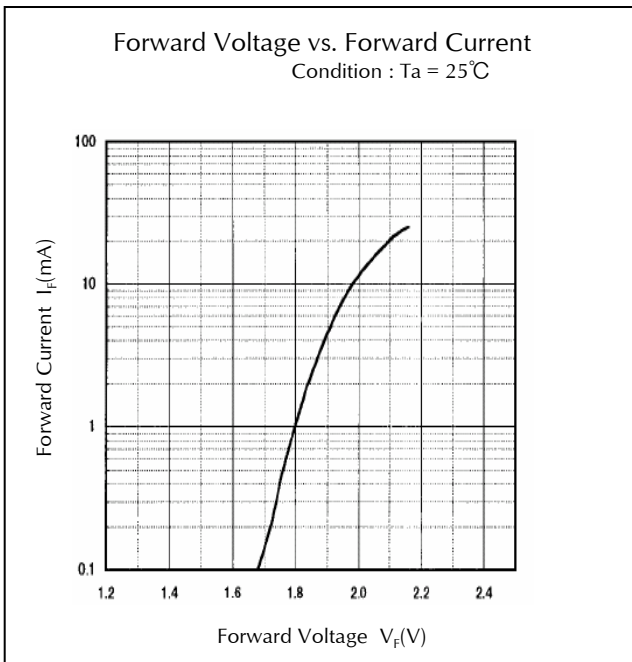
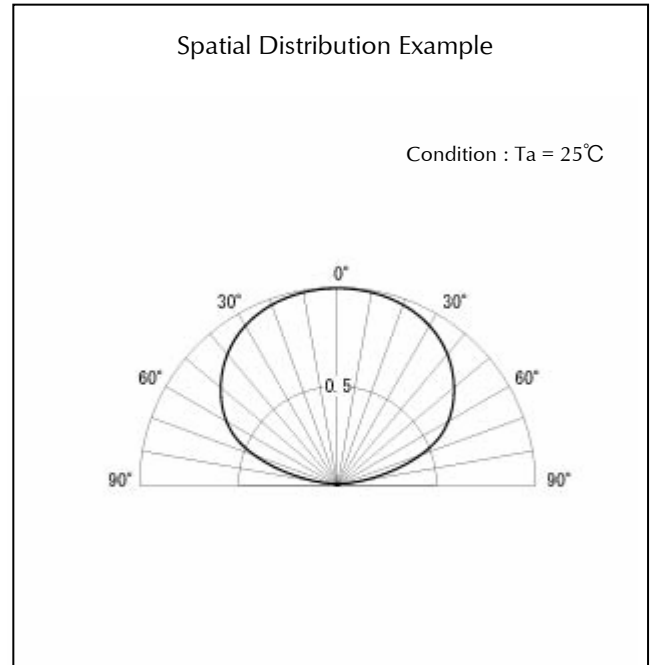
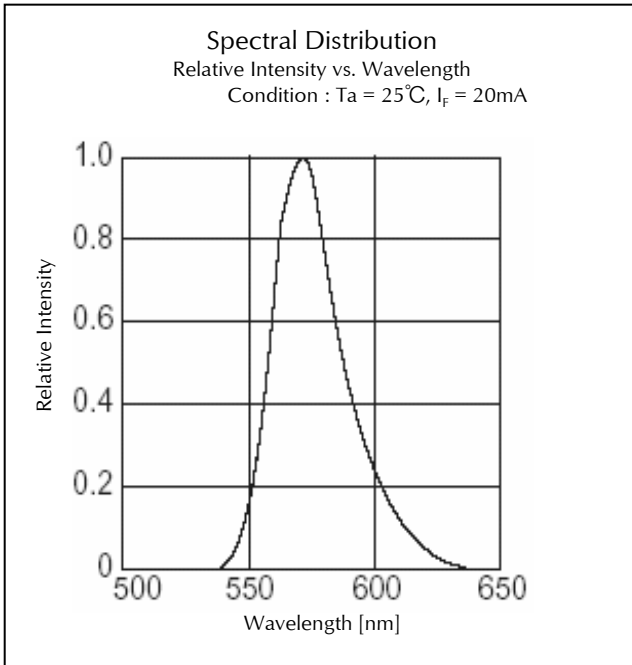
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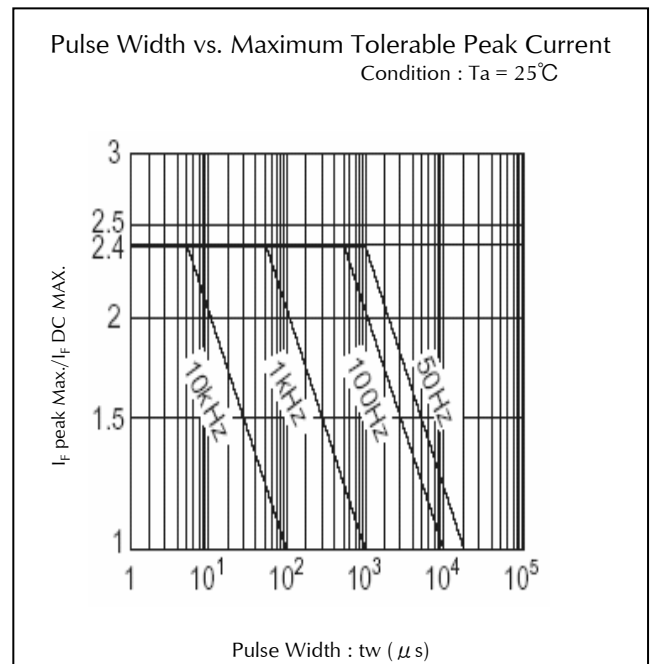
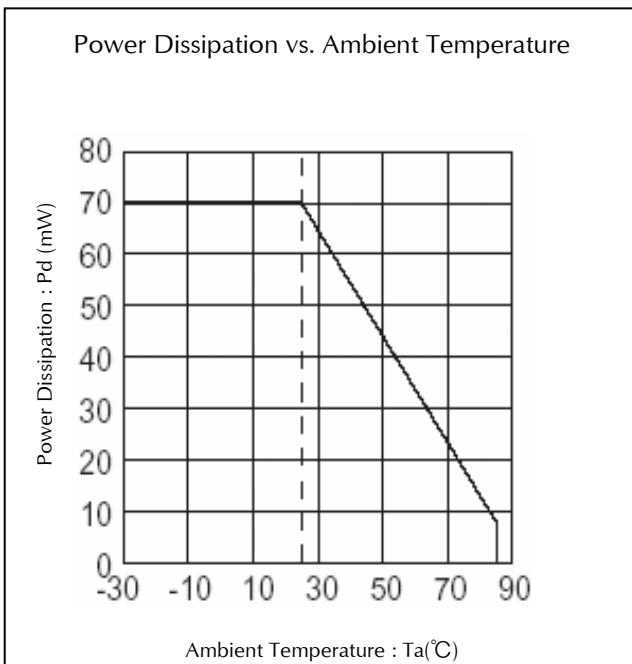
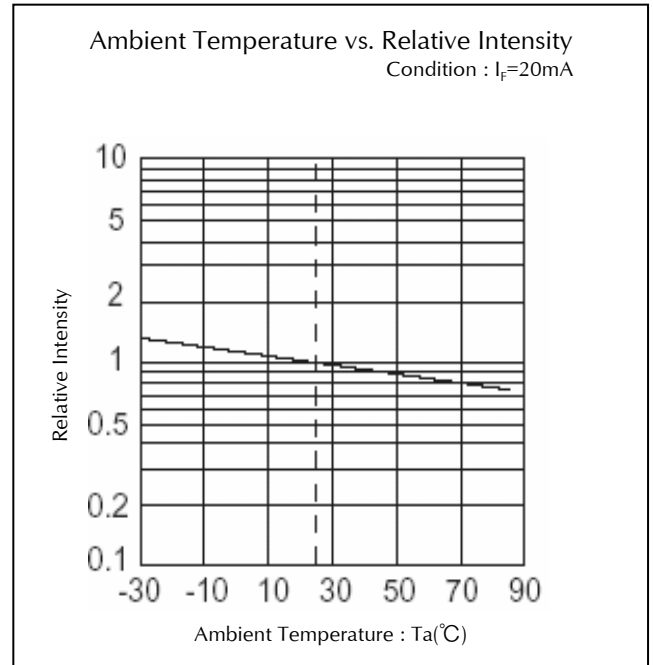
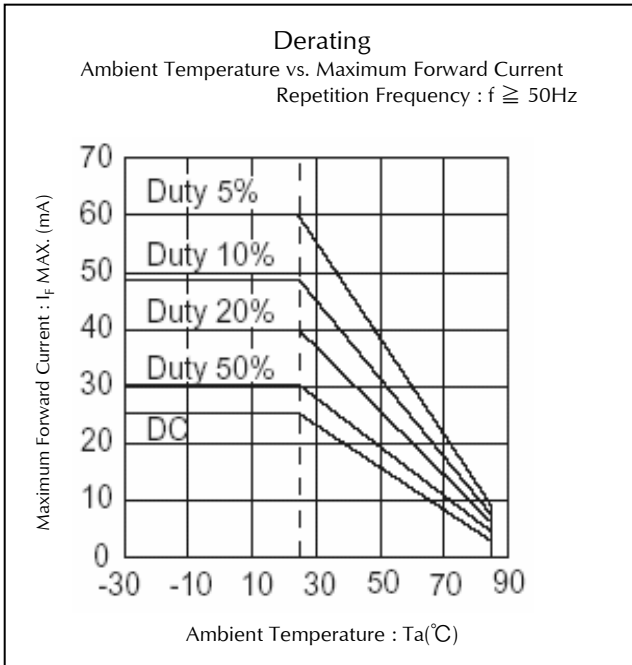
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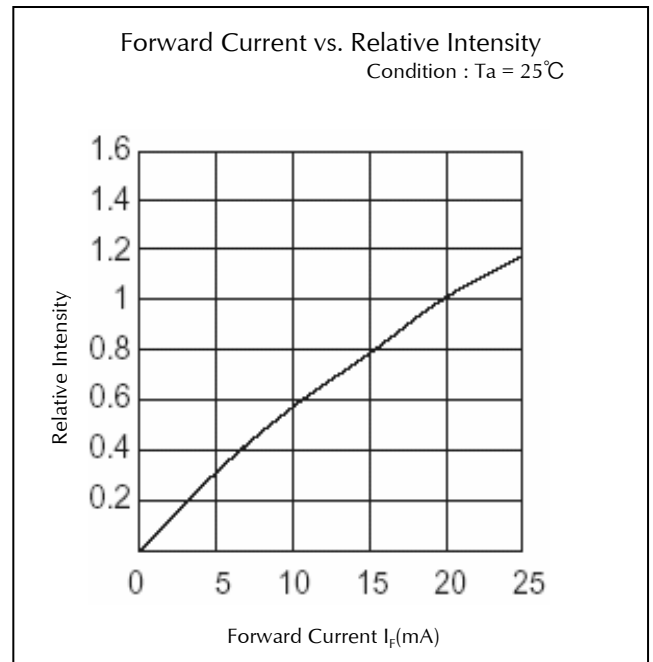
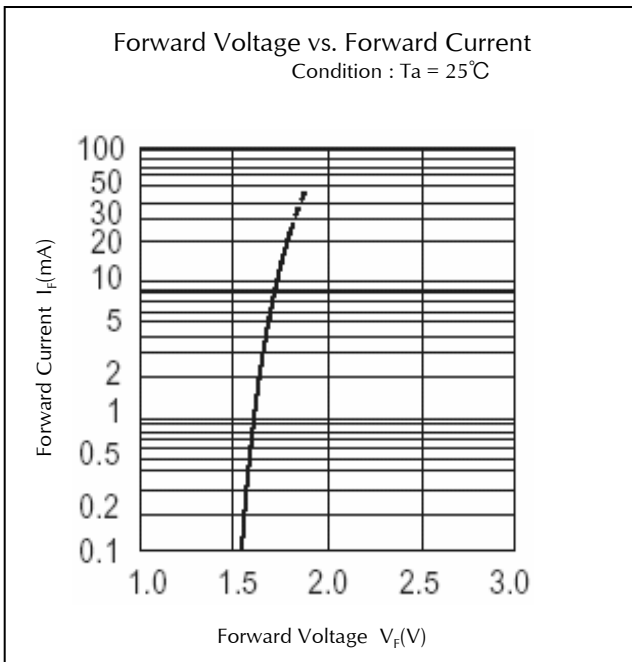
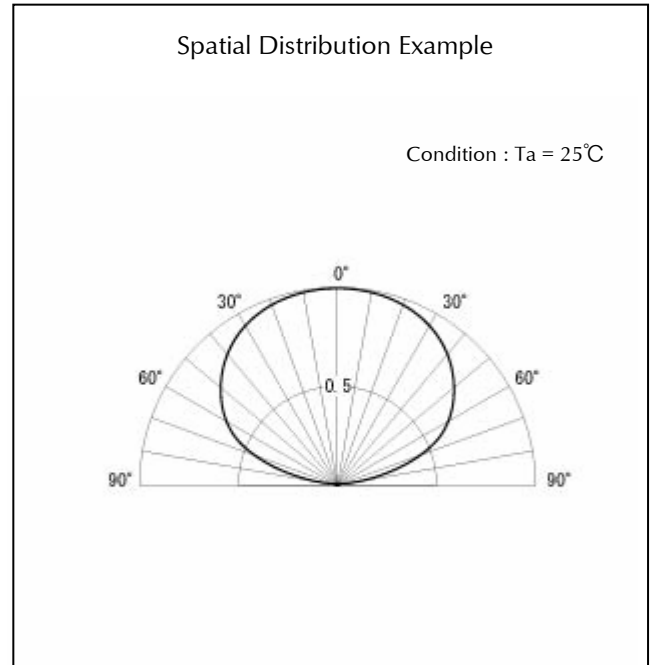
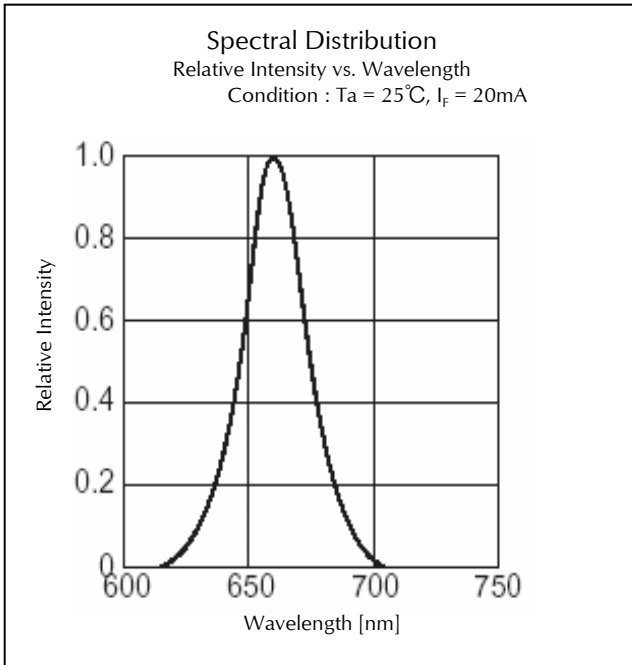
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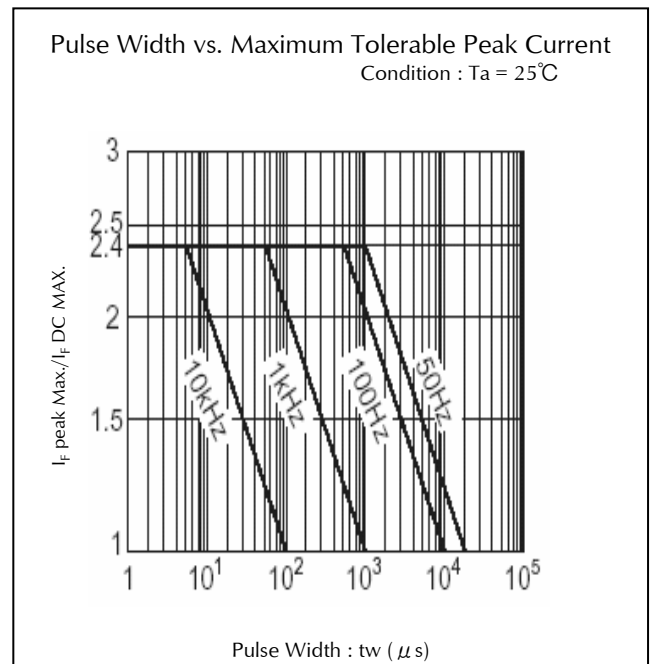
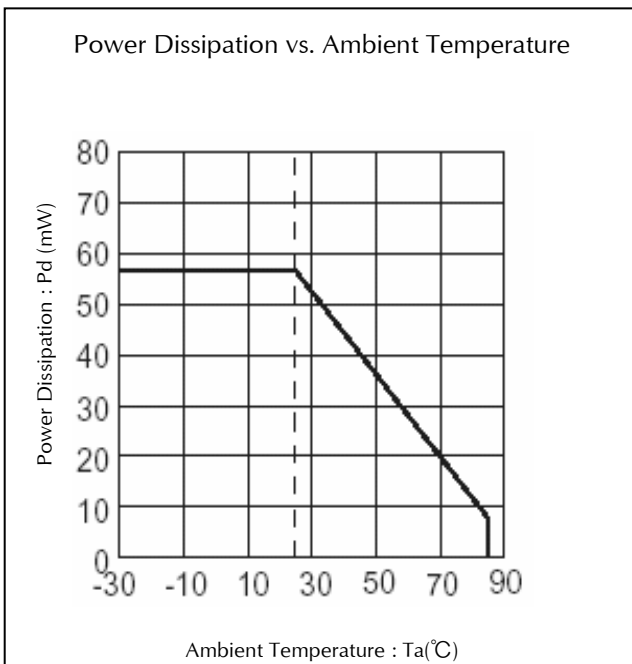
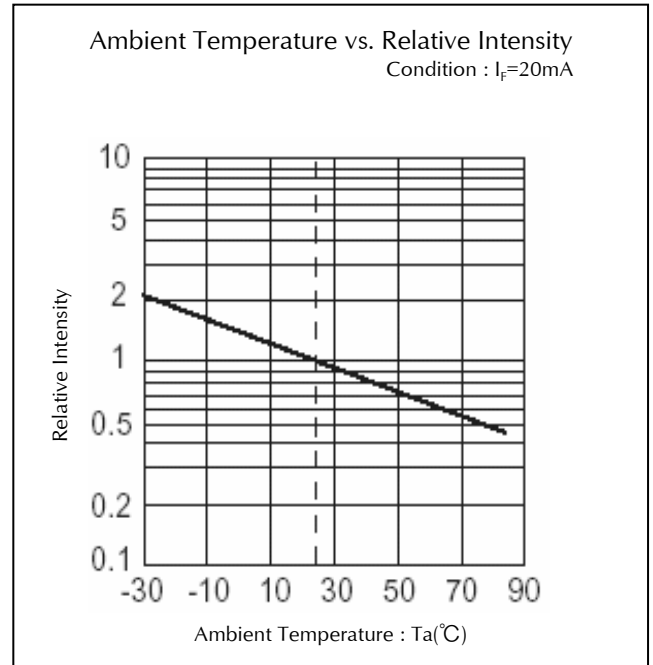
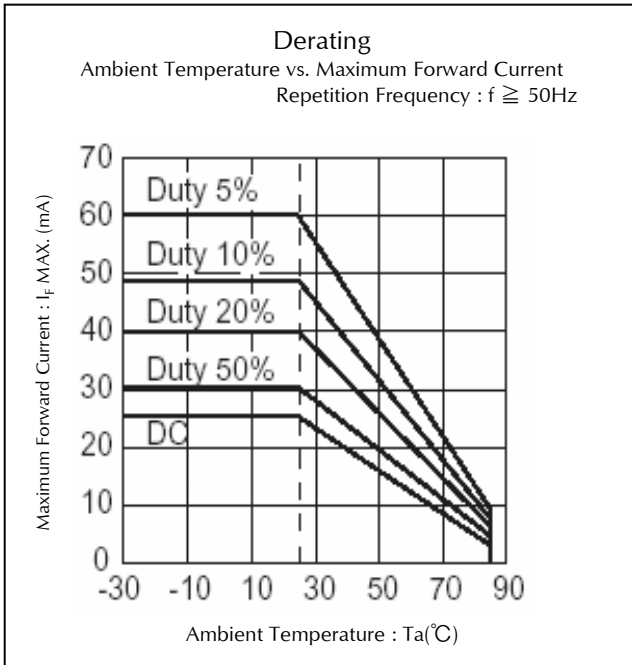
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Technical Data(BR)



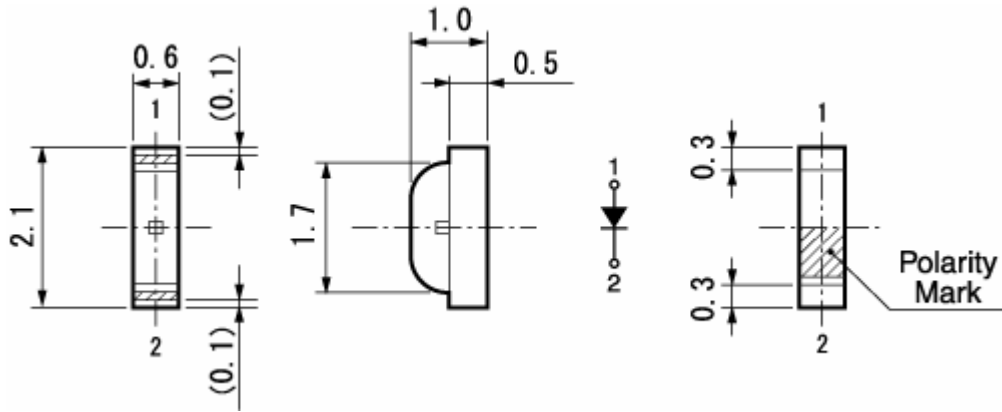
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Package Dimensions

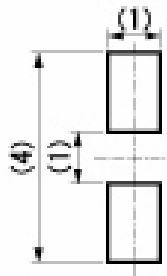
(Unit: mm)

Weight: (2.20)mg



Recommended Soldering Pattern

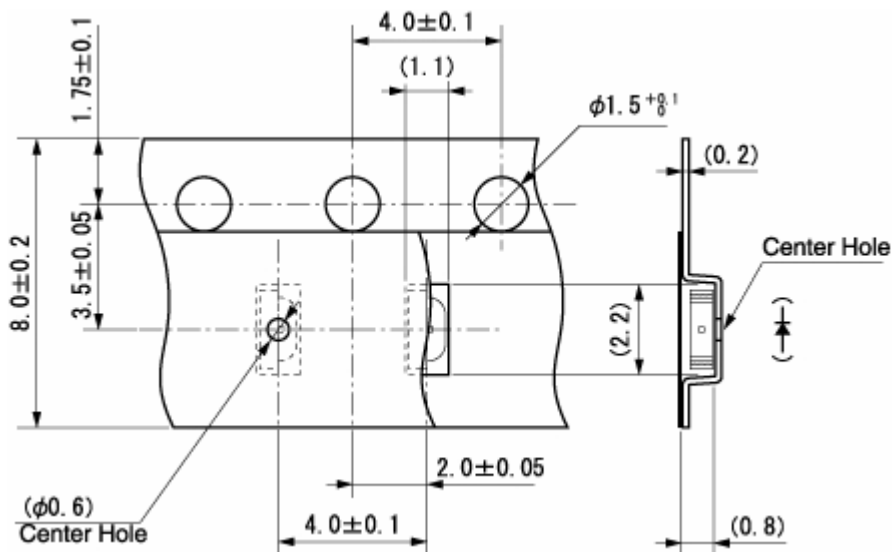
(Unit: mm)



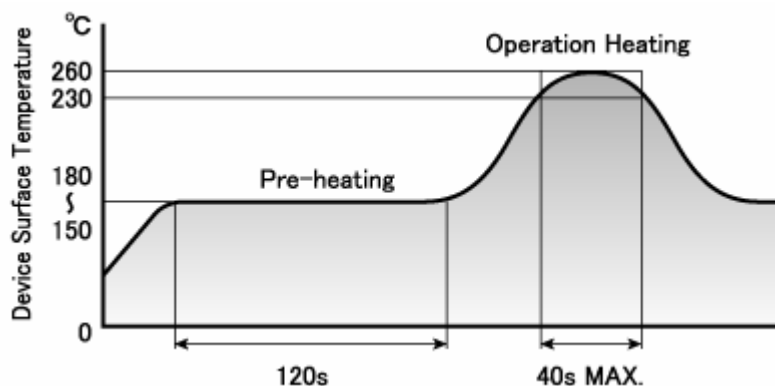
Taping Specification

(Unit: mm)

Quantity : 4,000pcs/ reel (standard)



Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized.

Manual Soldering Conditions

Iron tip temp. 350 °C (MAX.)

Soldering time and frequency 3 s (MAX.)
1 time (MAX.)

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(301)	Pre-heating : 150~180°C 120s Max. Operation Heating : 230°C 40s Max. Peak Temperature : 260°C	Twice	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	If Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	If Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking

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